IRL630

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V) R_{DS(on)} (Ω)

Q_{as} (nC)

Q_{gd} (nC)

Q_q (Max.) (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.40

200 V

40

5.5

24

Single

 $V_{GS} = 5 V$

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- 150 °C operating temperature
- Fast switching
- Ease of paralleling
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRL630PbF		
Lead (Pb)-free and halogen-free	IRL630PbF-BE3		

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	200	V	
Gate-source voltage			V _{GS}	± 10	v	
Continuous drain current		T _C = 25 °C	1	9.0		
	V _{GS} at 5 V	T _C = 100 °C	ID	5.7	A	
Pulsed drain current ^a			I _{DM}	36	1	
Linear derating factor				0.59	W/°C	
Single pulse avalanche energy ^b			E _{AS}	250	mJ	
Repetitive avalanche current ^a			I _{AR}	9.0	А	
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ	
Maximum power dissipation	T _C = 25 °C		PD	74	W	
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Soldering recommendations (peak temperature) ^d	For 10 s			300 ^d	1	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 25$ V, starting $T_J = 25$ °C, L = 4.6 mH, $R_g = 25 \Omega$, $I_{AS} = 9.0$ A (see fig. 12)

c. $I_{SD} \le 9.0$ A, dV/dt ≤ 120 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62		
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	1.7		

SPECIFICATIONS $(T_J = 25 \degree C, T_J = 25 \degree$	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	OTHEOE	1201				117-73.		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	V _{GS} = 0 V, I _D = 250 μA		-	-	V	
V _{DS} temperature coefficient	ΔV _{DS} /T _J		to 25 °C, I _D = 1 mA	-	0.27	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}		_{GS} , I _D = 250 μA	1.0	-	2.0	V	
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 10$		-	-	± 100	nA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		-	-	25	- μA	
Zero gate voltage drain current	I _{DSS}			-	-	250		
		V _{GS} = 5.0 V	I _D = 5.4 A ^b	-	-	0.40	-	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 4.0 V$	I _D = 4.5 A ^b	-	-	0.50	Ω	
Forward transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D = 5.4 A ^b	4.8	-	-	S	
Dynamic					•			
Input capacitance	C _{iss}	<u> </u>		-	1100	-	pF	
Output capacitance	C _{oss}	V	V _{GS} = 0 V V _{DS} = 25 V		220	-		
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	70	-		
Total gate charge	Qg		I _D = 9.0 A, V _{DS} = 160 V, see fig. 6 and 13 ^b	-	-	40	nC	
Gate-source charge	Q _{gs}	V _{GS} = 10 V		-	-	5.5		
Gate-drain charge	Q _{gd}	-		-	-	24		
Turn-on delay time	t _{d(on)}				8.0	-	- ns	
Rise time	t _r	V_{DD} = 100 V, I _D = 9.0 A R _g = 6.0 Ω, R _D = 11 Ω, see fig. 10 ^b		-	57	-		
Turn-off delay time	t _{d(off)}			-	38	-		
Fall time	t _f				33	-		
Internal drain inductance	L _D	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.5	-		
Internal source inductance	L _S	package and center of die contact		-	7.5	-	- nH	
Drain-Source Body Diode Characteristic	s				•	•		
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	9.0	A	
Pulsed diode forward current ^a	I _{SM}	p - n junction diode		-	-	36		
Body diode voltage	V _{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 9.0 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.0	V	
Body diode reverse recovery time	t _{rr}	- $T_J = 25 \text{ °C}, I_F = 9.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	230	350	ns	
Body diode reverse recovery charge	Q _{rr}			-	1.7	2.6	μC	
Forward turn-on time	t _{on}	Intrinsic turn	-on time is negligible (turn	-on is do	minated b	by L _S and	L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

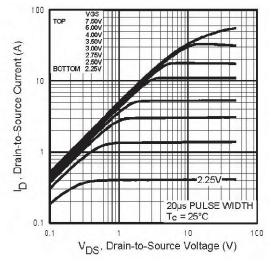


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

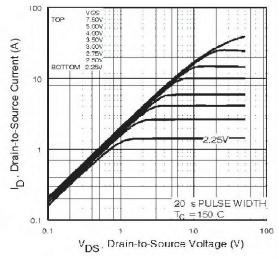


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

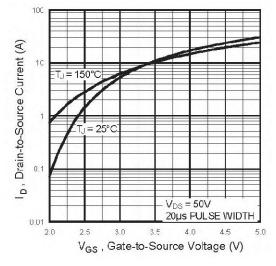


Fig. 3 - Typical Transfer Characteristics

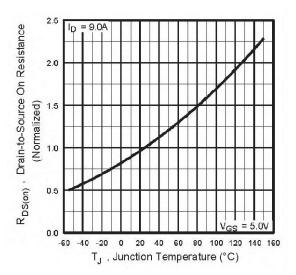


Fig. 4 - Normalized On-Resistance vs. Temperature

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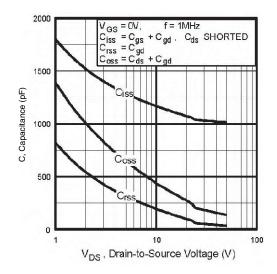


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

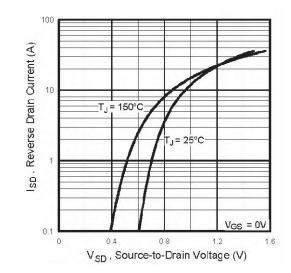


Fig. 7 - Typical Source-Drain Diode Forward Voltage

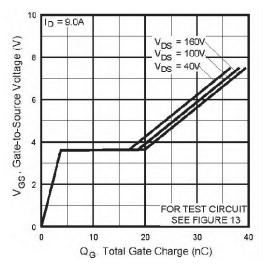


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

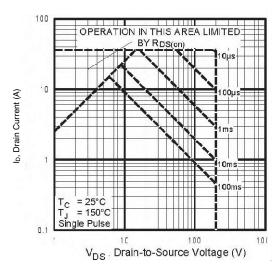


Fig. 8 - Maximum Safe Operating Area

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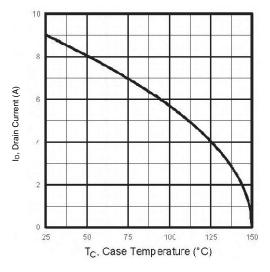


Fig. 9 - Maximum Drain Current vs. Case Temperature

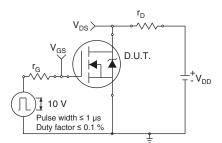


Fig. 10a - Switching Time Test Circuit

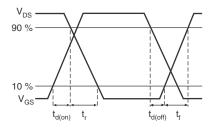


Fig. 10b - Switching Time Waveforms

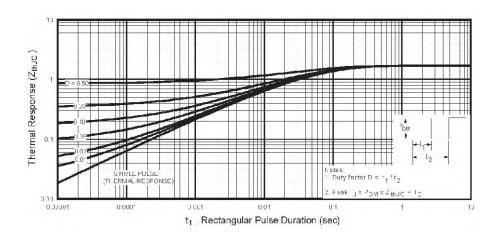


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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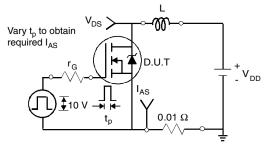


Fig. 12a - Unclamped Inductive Test Circuit

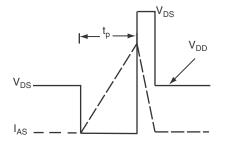
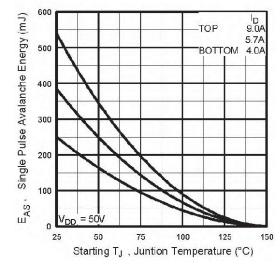
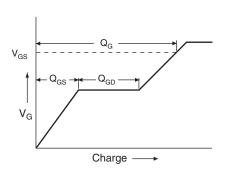


Fig. 12b - Unclamped Inductive Waveforms









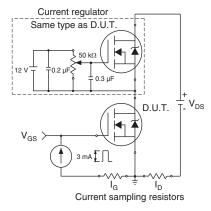


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

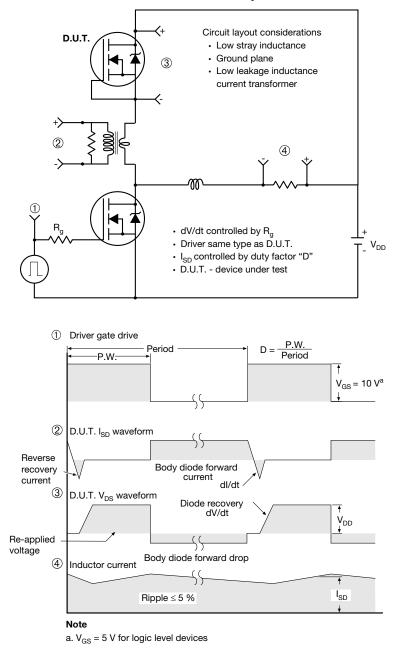


Fig. 14 - For N-Channel

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